Introduction to Microcontrollers

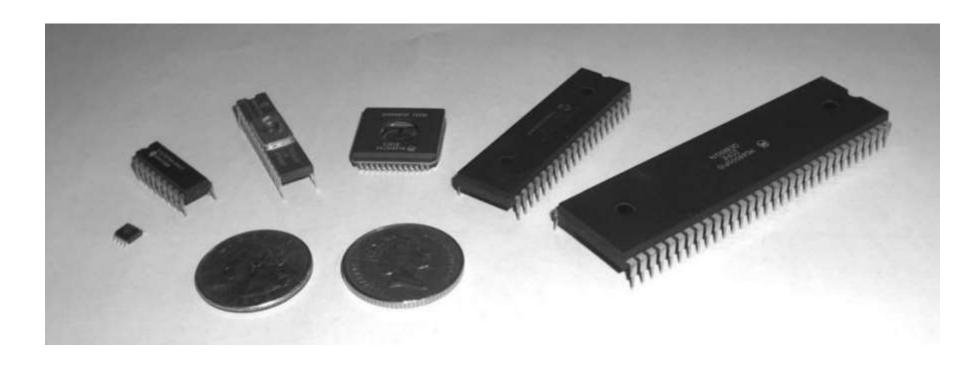
Outline

- Definition of Microcontroller
- Types of Microcontrollers
- Microcontroller Architecture
- Core Microcontroller Components
- Peripheral Microcontroller Components
- Internal and External Operation of Microcontrollers
- Advantages of Microcontrollers
- Application Areas of Microcontrollers
- A Typical Microcontroller Application
- Microcontroller vs. Microprocessor
- Choosing a Microcontroller for a Specific Application

Definition of Microcontroller

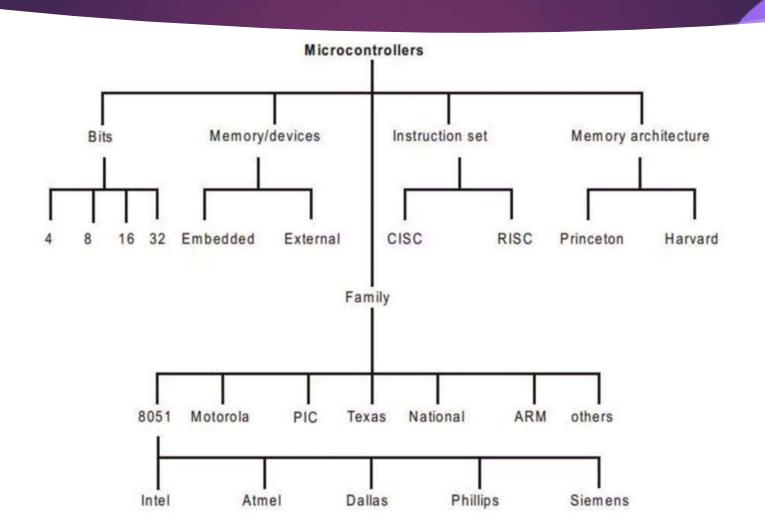
- ► A microcontroller is an integrated circuit (IC) that can be programmed to perform a set of functions to control a collection of electronic devices.
- A self-contained system in which a processor, support, memory, and input/output (I/O) are all contained in a single package.
- Being programmable is what makes the microcontroller unique.

Definition of Microcontroller (Continued)



From left to right: PIC 12F508, PIC 16F84A, PIC 16C72, Motorola 68HCO05B16, PIC 16F877, Motorola 68000.

Types of Microcontrollers



- ALU performs arithmetic and logical operations on a nibble (4-bits) at an instruction.
- Internal bus width is 4-bit.
- Small size, minimum pin count and low cost controllers.
- ► Low power consumption and used for low end applications like LED & LCD display drivers, portable battery chargers etc.
- ► Examples: Renasa M34501 256 and ATAMS862 series from Atmel.

- ▶ ALU performs arithmetic and logical operations on a byte (8-bits) at an instruction.
- ▶ Internal bus width is 8-bit.
- Examples: Intel 8051 family and Motorola MC68HCI11 family.

- ALU performs arithmetic and logical operations on a word (16-bits) at an instruction.
- Internal bus width of 16-bit microcontroller is 16-bit.
- ► Enhanced performance, computing capability and precision as compared to the 8-bit microcontrollers.
- Examples: Intel 8096 family, Motorola MC68HCI12 and MC68332 families.

- ▶ ALU performs arithmetic and logical operations on a double word (32-bits) per instruction.
- Internal bus width is 32-bit.
- Much more enhanced performance, computing capability with greater precision as compared to 16-bit microcontrollers.
- Examples: Intel 80960 family, Motorola M683xx and Intel/Atmel 251 family.

Embedded Microcontrollers

- An embedded system has a microcontroller unit that has all the functional blocks (including program as well as data memory) available on a the same chip.
- Example: 8051 having Program & Data Memory, I/O Ports, Serial Communication, Counters and Timers and Interrupt Control logic on the chip.

An Embedded PIC Microcontroller



External Memory Microcontrollers

- An external system has a microcontroller unit that does not have all the functional blocks available on a chip.
- All or part of the memory units are externally interfaced using an interfacing circuit called the glue circuit.
- ► Example: Intel 8031 has no program memory on the chip.

An External Memory Microcontroller



CISC Microcontrollers

- ► Has an instruction set that supports many addressing modes for the arithmetic and logical instructions, data transfer and memory accesses instructions.
- Many of the instructions are macro like.
- Allows the programmer to use one instruction in place of many simpler instructions.
- Example: Intel 8096 family.

RISC Microcontrollers

- Contains an instruction set that supports fewer addressing modes for the arithmetic and logical instructions and for data transfer instructions.
- Allows simultaneous access of program and data.
- Instruction pipelining increases execution speed.
- Allow each instruction to operate on any register or use any addressing mode.
- Smaller chip and pin count.
- Very low power consumption.

CISC vs RISC Microcontroller

Feature

Instruction Set

Instructions per Task

Instruction Length

Execution Time

Hardware Complexity

Code Size

Power Consumption

Performance

Examples

CISC (Complex Instruction Set Computer)

Large and complex

Fewer (single complex instruction can do a lot)

Variable

Slow (some instructions take multiple

cycles)

More complex (needs to decode

complex instructions)

Smaller (fewer instructions needed)

Higher

Good for complex tasks

Intel 8051, x86 family

RISC (Reduced Instruction Set Computer)

Small and simple

More (simple instructions combined)

Fixed

Fast (one instruction per cycle)

Simpler

Larger (more instructions required)

Lower

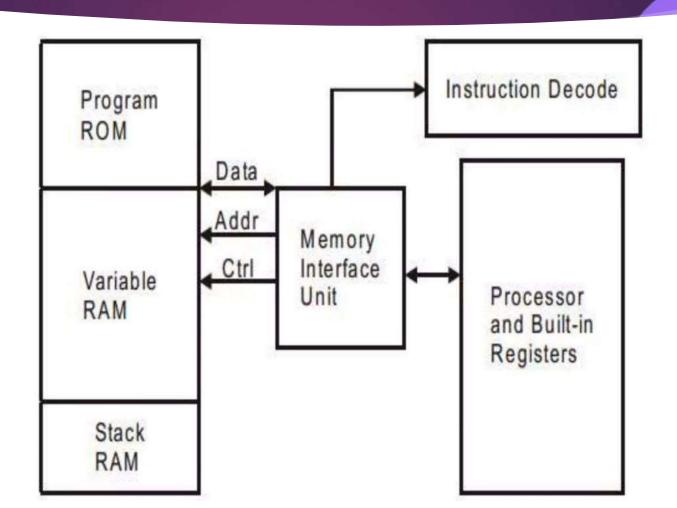
Faster for simpler tasks

ARM Cortex-M, AVR, MIPS

Von-Neuman Architecture

- Single data bus that is used to fetch both instructions and data.
- Program instructions and data are stored in a common main memory.
- When such a controller addresses main memory, it first fetches an instruction, and then it fetches the data to support the instruction.
- Simplifies the microcontroller design because only one memory is accessed.
- ▶ The weakness is that two separate fetches can slow up the controller's operation.
- ► Example: Motorola 68HC11.

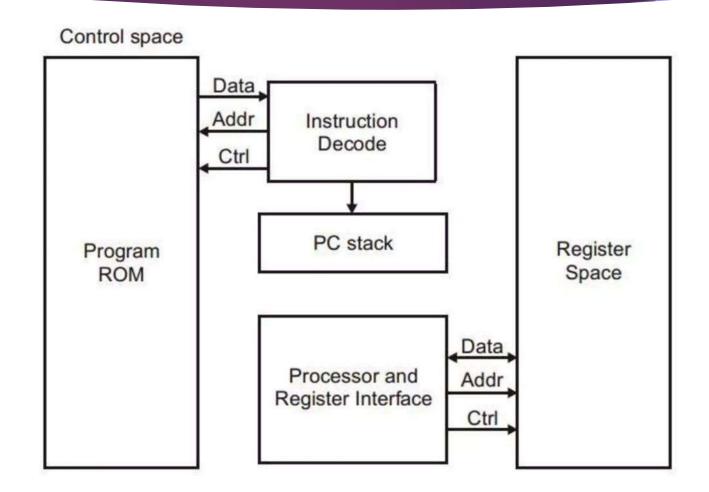
Von-Neuman Architecture Block Diagram



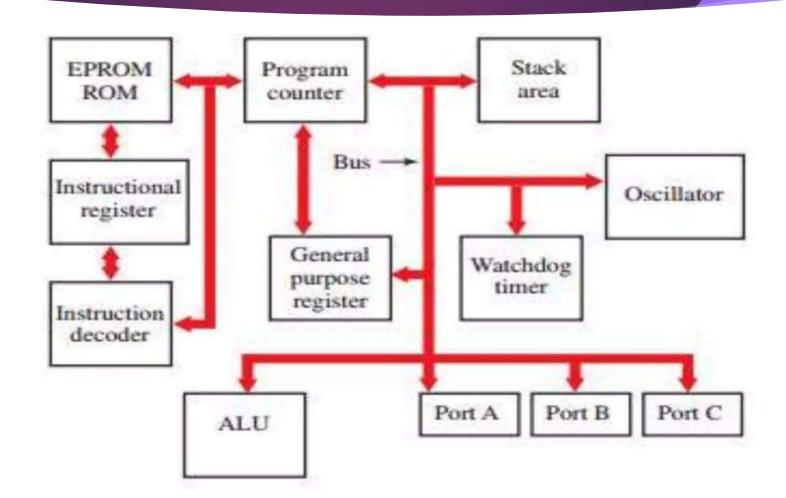
Harvard Architecture

- Separate data bus and an instruction bus.
- Execution occur in parallel.
- Much faster execution than Von-Neuman architecture.
- Design complexity.
- Example: Intel MCS-51 family and PIC microcontrollers.

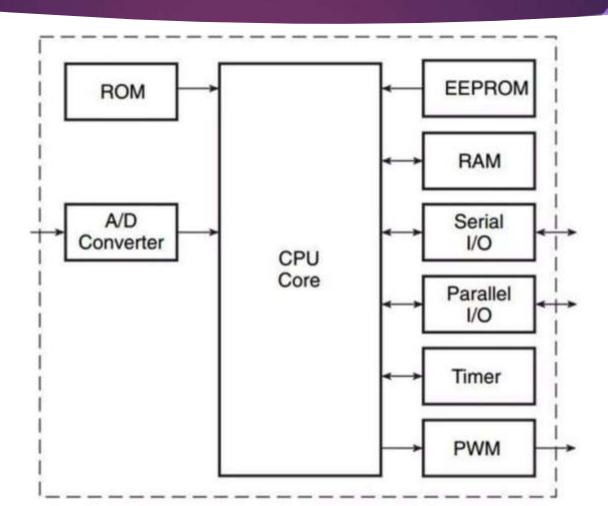
Harvard Architecture Block Diagram



Microcontroller CPU Architecture Block Diagram



Generalized Microcontroller Architecture Block Diagram



Core Microcontroller Components

- ▶ <u>CPU</u>: The Central Processing Unit (CPU) processes the program. It executes the instructions stored in the program memory pointed to by the program counter in synchronization with the clock signal.
- ▶ <u>ALU:</u> The Arithmetic/Logic Unit (ALU) performs mathematical and logical operations on data.
- ▶ <u>Oscillator:</u> A complex digital device that generates steady pulse rate required for timing. All of the separate functions are controlled by one central timing system. The timing pulse provides the basis for proper sequence of all the separate sections of the microcontroller chip.

Read Only Memory (ROM): ROM holds the program instructions and the constant data. Microcontrollers use one or more of the following memory types for this purpose:

- ROM (mask-programmed ROM)
- PROM (one-time programmable ROM, which is not field programmable)
- EPROM (field programmable and usually UV erasable)
- ► EEPROM (field programmable, electrically erasable, byte erasable) and flash (similar to EEPROM).
- Microcontrollers can have 4K, 8K and 16K, etc. of ROM

Random Access Memory (RAM):

- Is used to hold intermediate results and other temporary data during the execution of the program.
- Typically, microcontrollers have a few hundreds of bytes of RAM.

Registers:

Register is used to hold the contents of data being manipulated.

Special-Function Registers:

- Control various functions of a microcontroller.
- These are divided into two groups:
 - Registers Wired into the CPU
 - ▶ Do not necessarily form part of addressable memory.
 - ▶ Used to control program flow and arithmetic functions.
 - ► Examples: status register, program counter, stack pointer, etc.
 - Registers Required by Peripheral Components
 - ▶ The contents of these registers include set a timer or enable serial communication.
 - Examples: A program counter, stack pointer, RAM address register, program address register, and incrementor register.

Watchdog timer:

- ▶ A specialized program found as part of the microcontroller designed to prevent the microcontroller from halting or "locking up" because of a user-written program since the instructions are processed step-by-step.
- Uses a routine that is based on timing.
- ▶ If a program has not been completed or repeated as a loop within a certain amount of time, the watchdog timer issues a reset command.
- A system reset sets all the register values to zero.
- The reset feature allows the microcontroller to recover from a crash.
- ▶ It releases the program and sets the MCU to start over again.

Stack pointer:

Keeps track of the last stack location used while processor is busy manipulating checking ports, or checking interrupts.

Program counter:

Is used to hold the address of the instruction to be executed next.

Buses:

▶ Bus represents a physical connection used to carry a signal from one point to another inside a microcontroller. The signal carried by a bus may represent address, data, control signal, or power.

Peripheral Microcontroller Components

The analog-to-digital converter:

Provides an interface between the microcontroller and the sensors that produce analogue electrical equivalents of the actual physical parameters to be controlled.

The digital-to-analog converter:

Provides an interface between the microcontroller and the actuators that provide the control function.

I/O ports:

Provide an interface between the microcontroller and the peripheral I/O devices such as the keyboard, display, etc.

Counters/timers:

Are used to keep time and/or measure the time interval between events, count the number of events and generate baud rate for the serial ports.

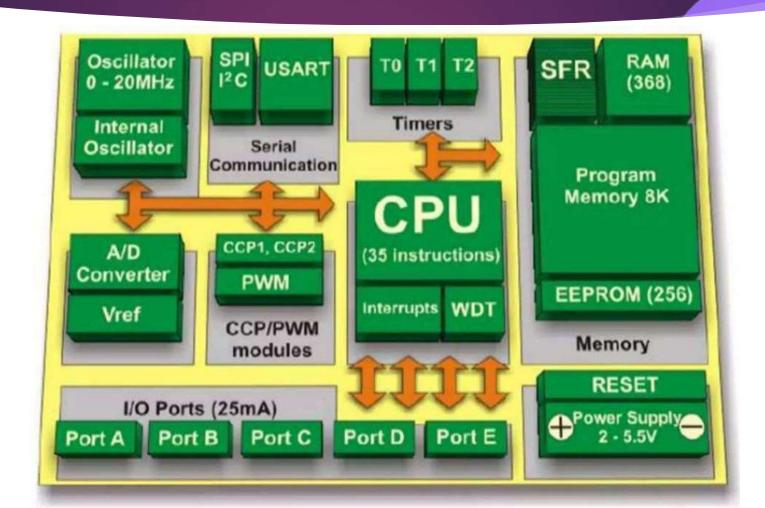
Microcontroller Internal Operation

- ► The microcontroller consists of thousands of digital circuits that are combined into areas to provide specific functions.
- ► The CPU components of a microcontroller are used to save data and programs, perform math and logic functions, and generate timing signals.
- ► The different areas are connected by a bus system. The bus system contains tiny parallel circuits that carry the digital pulse patterns from section to section.
- ► The ROM stores the program required for the microcontroller to function and controls how the chip components operate and how data and instructions flow through the chip.
- RAM stores programs and data temporarily.
- Ports and registers are special memory locations dedicated to a specific function such as a hardware location or a place to manipulate data.

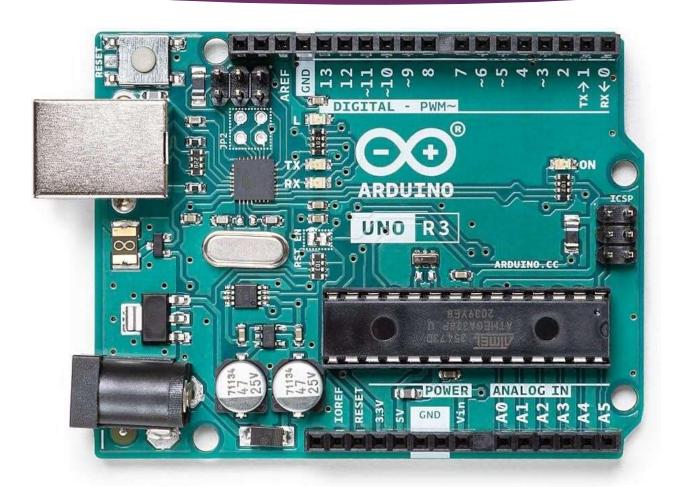
Microcontroller External Operation

- When a microcontroller is mounted on a circuit board with other components, it functions as a single unit, and is referred to as a module or a microcontroller development board.
- A microcontroller module typically consists of a microcontroller, a power source, an interface for connecting to a programming device, I/O ports, and additional memory.
- ▶ A power source powers the microcontroller and any accompanying components located on the printed circuit board.
- An interface communicates with the microcontroller.
- A set of input/output (I/O) ports send and receive signals from the devices the microcontroller is designed to control. I/O ports when programmed as an output pin, each pin can output digital signals. When programmed as an input pin, each pin can receive digital signals.
- Digital-to-analog and analog-to-digital converters change the digital pulses into analog signals.

Microcontroller External Operation Block Diagram



Arduino Uno – An Atmel ATMega328P Development Board



Advantages of Microcontrollers

- **Cost-Effective**: Microcontrollers are typically inexpensive, making them ideal for mass-produced devices and applications where cost is a major factor.
- Low Power Consumption: Many microcontrollers are designed to operate at low power, making them suitable for battery-operated devices and energy-efficient applications.
- **Compact Size**: Their small size allows them to be embedded directly within devices, even in small or portable electronics.
- **Real-Time Processing**: Microcontrollers can handle real-time tasks, making them ideal for applications where timing is critical, like robotics, automotive controls, and industrial automation.
- **Ease of Programming and Use**: Most MCUs support straightforward programming, with development environments (like Arduino IDE) that make it accessible to both beginners and professionals.
- **Integrated Peripherals**: They often come with built-in peripherals (such as ADCs, timers, UART, I2C, SPI) that simplify interfacing with sensors, actuators, and other components.

 Single-Chip Solution: A microcontroller combines CPU, memory, and I/O peripherals on a single chip,
- reducing the need for additional components and saving space.
- Reliability: Due to their simplicity and dedicated functionality, MCUs are reliable and have lower failure rates, which is essential for mission-critical applications.
- Flexible Development Options: Microcontrollers support a variety of programming languages and have a wide ecosystem of libraries, frameworks, and community support.
- ▶ Stable and Long-Term Support: Unlike complex computer processors, MCUs have a stable architecture, which ensures software longevity and reduces the need for frequent hardware updates.

Application Areas of Microcontrollers

Consumer Electronics

- **Home Appliances**: Washing machines, microwaves, refrigerators, and air conditioners often use microcontrollers to manage operations.

 Smart Home Devices: Lighting systems, thermostats, security systems, and smart door locks.
- Wearable Technology: Smartwatches, fitness trackers, and health monitors.

Automotive Applications

- **Engine Control Systems**: Engine management and fuel injection control for optimized performance.
- **Safety Systems**: Anti-lock braking systems (ABS), airbag control, and stability control.
- **Infotainment**: Entertainment systems, display controls, and navigation systems.
- **Telematics**: Communication systems for vehicle data transmission and diagnostics.

Industrial Automation

- **Process Control**: Monitoring and control of processes in manufacturing, chemical plants, and food production.
- **Robotics**: Controlling robotic arms, automated guided vehicles (AGVs), and CNC machines.
- Sensors and Actuators: Temperature, pressure, and other sensors for feedback and control systems.

 Medical Devices

- **Portable Medical Equipment**: Blood pressure monitors, glucose meters, and heart rate monitors.
- **Diagnostic Equipment**: Ultrasound machines, ECG machines, and MRI machines. **Implantable Devices**: Pacemakers and insulin pumps, where low power and reliability are critical.

Telecommunications

- **Networking Equipment**: Routers, modems, and switches for managing data traffic.
- **Signal Processing**: Devices for encoding, decoding, and modulation.
- **Remote Monitoring**: Equipment used in remote cellular towers for monitoring and maintenance.

Application Areas of Microcontrollers (Continued)

- **Internet of Things (IoT)**
 - **Smart Cities**: Waste management, smart street lighting, and environmental monitoring.

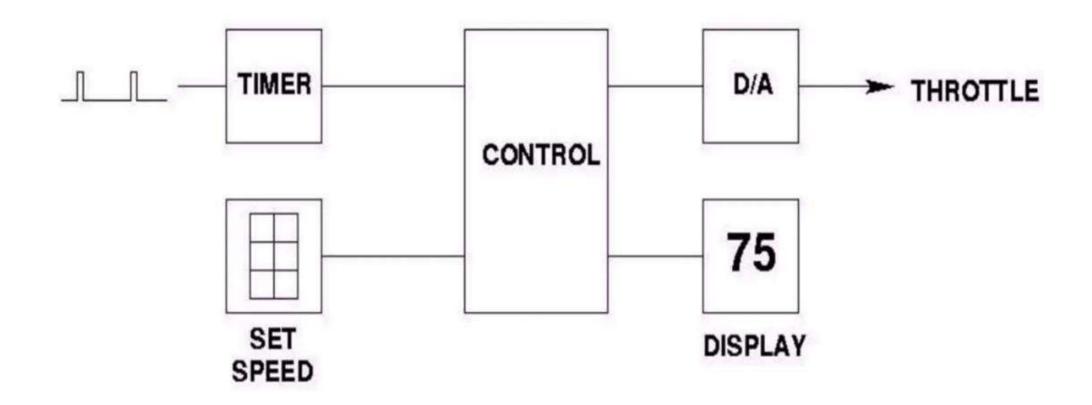
 - **Agriculture**: Soil moisture sensors, weather stations, and crop monitoring systems. **Asset Tracking**: For logistics, tracking, and monitoring the condition of goods in transit.
- **Aerospace and Defense**

 - **Avionics**: Flight control systems, navigation, and autopilot. **Missile Guidance and Control**: For precision in targeting and flight path correction.
 - Military Communications: Secure and low-power communication systems for soldiers and equipment. Education and Research
- - **STEM Education Kits**: Microcontrollers like Arduino and Raspberry Pi are used widely in educational kits to teach programming and electronics.
 - **Prototyping and Testing**: For building and testing new electronic designs in academic research labs and R&D.
- **Environmental Monitoring**
 - **Weather Stations**: Monitoring temperature, humidity, wind speed, and other weather conditions.
 - **Pollution Monitoring**: Air and water quality measurement devices for industrial and environmental monitoring.
 - **Wildlife and Habitat Monitoring**: Remote sensors for tracking animals and monitoring habitats.
- **Renewable Energy**
 - **Solar Power Systems**: Controllers for solar panels, battery management, and tracking systems. **Wind Turbines**: Control systems for optimizing turbine angle and power output.

 - **Energy Meters**: Smart metering devices for monitoring and controlling energy use.

A Typical Microcontroller Application – Automobile Cruise Control

Speed Measurement



Comparison Between Microcontroller and Microprocessor

	Microprocessor	Microcontroller
Applications	General computing (i.e. Laptops, tablets)	Appliances, specialized devices
Speed	Very fast	Relatively slow
External Parts	Many	Few
Cost	High	Low
Energy Use	Medium to high	Very low to low
Vendors	intel AMD	TEXAS INSTRUMENTS MICROCOMP

Criteria of Choosing a Microcontroller

Processing Power (CPU Architecture and Clock Speed)

CPU Architecture: ARM, AVR, PIC, RISC-V, etc. Some architectures are better for specific applications, such as

ARM for high-performance applications.

Clock Speed: Determines the speed at which the MCU can process instructions. Applications requiring real-time processing or fast data handling need higher clock speeds.

Memory (RAM and Flash)

Flash Memory: For storing the program code. Applications with complex code or large libraries need more flash

RAM: For storing variables and temporary data during runtime. Memory-intensive applications (like those using complex algorithms or handling large datasets) require more RAM.

I/O Capabilities

GPIO Pins: Number and type of general-purpose I/O pins. Consider whether the MCU has enough pins for the

components and sensors you plan to connect.

Analog Inputs/Outputs: For analog sensors, ensure the MCU has enough ADC (Analog-to-Digital Converter)

channels and DAC (Digital-to-Analog Converter) support if needed.

Power Consumption

Active/Idle Power: Essential for battery-powered applications. Some MCUs offer low-power modes to conserve

Power Modes: Look for ultra-low-power or sleep modes if low energy consumption is critical, as in IoT or

wearable devices. Communication Interfaces

UART, SPI, I2C: Basic communication protocols. Multiple peripherals often require various protocols.

CAN, USB, Ethernet, Wi-Fi, Bluetooth: Specialized protocols for specific applications, such as automotive (CAN), networking (Ethernet), or wireless communication (Bluetooth/Wi-Fi).

Operating Voltage

Ensure compatibility with other components in the circuit, as some MCUs operate at 5V, while others operate at 3.3V or lower.

Criteria of Choosing a Microcontroller (Continued)

Package Type and Size

- **Physical Size and Form Factor**: Depending on the project, consider the size (e.g., DIP, QFN, or BGA). Small form factors may be essential for wearables or portable devices.
- **Ease of Soldering**: Some packages are easier to solder manually, while others might require specialized tools or manufacturing processes.

Cost

Choose an MCU that fits within the project's budget. Consider production volumes, as costs per

unit may vary greatly. **Development Tools and Ecosystem**

- **IDE Support**: Look for compatible Integrated Development Environments (IDEs) and libraries.
- **Documentation and Community**: Choose an MCU with good documentation, resources, and community support, which can simplify development and debugging. **Temperature and Environmental Specifications**

For applications in harsh environments, choose MCUs rated for extreme temperatures or high humidity conditions.

Security Features

For applications where data security is critical, consider MCUs with encryption modules, secure boot, and tamper detection features.

Production Availability and Longevity

Verify that the MCU will be available for the expected production lifetime of the product, as some MCUs may become obsolete quickly.





Transistor & Mosfet

Course Title: Embedded Systems and IoT

Course Code: CSE233

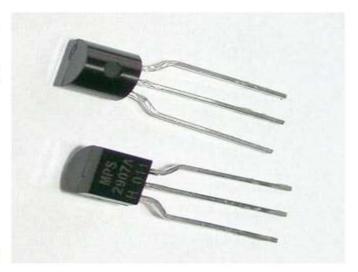
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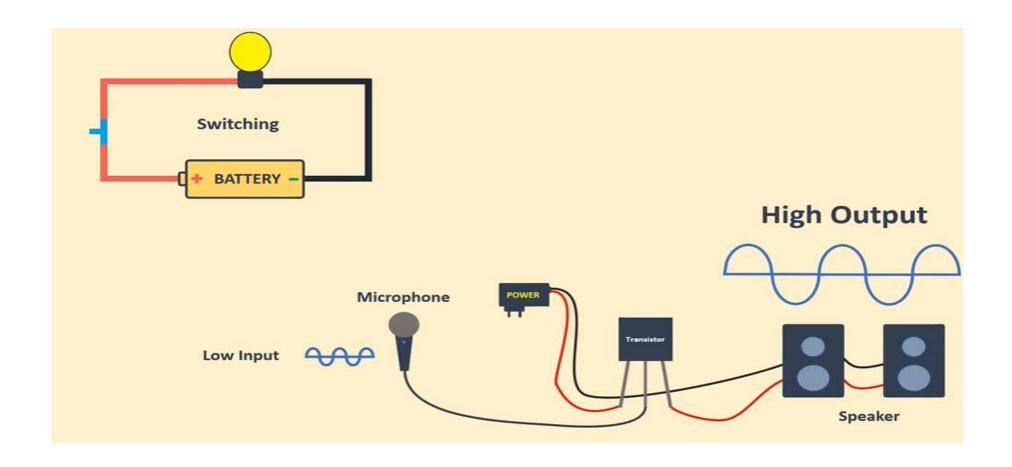
Transistor

- A transistor is a type of <u>semiconductor</u> device that can be **used to conduct** and insulate electric current or voltage. A transistor basically acts as a switch and an amplifier. In simple words, a transistor is a miniature device that is used to control or regulate the flow of electronic signals.
 - Semiconductors: ability to change from conductor to insulator
 - Can either allow current or prohibit current to flow
 - Useful as a switch, but also as an amplifier
 - Essential part of many technological advances

A transistor is a semiconductor device used to amplify and switch electronic signals and electrical power.



Use of transistor



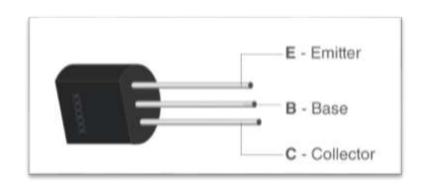
Parts of a Transistor

□ A typical transistor is composed of three layers of semiconductor materials or, more specifically, terminals which help to make a connection to an external circuit and carry the current. A voltage or current that is applied to any one pair of the terminals of a transistor controls the current through the other pair of terminals. There are three terminals for a transistor. They are listed below:

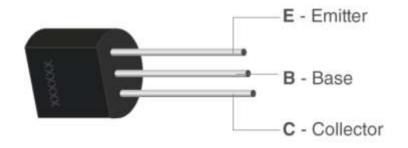
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*Base: This is used to activate the transistor.

*Collector: It is the positive lead of the transistor.

*Emitter: It is the negative lead of the
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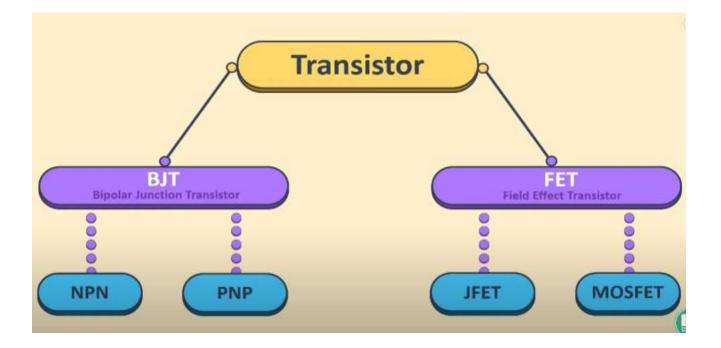
Parts of a Transistor



☐ Basic working principle of a transistor is based on controlling the flow of current through one channel by varying the intensity of a smaller current that is flowing through a second channel.

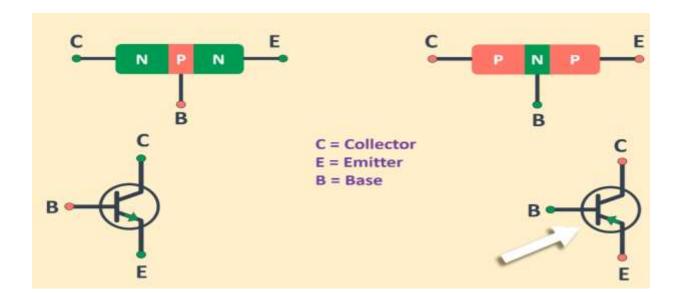
Types of Transistor

☐ There are mainly two types of transistors, based on how they are used in a circuit.



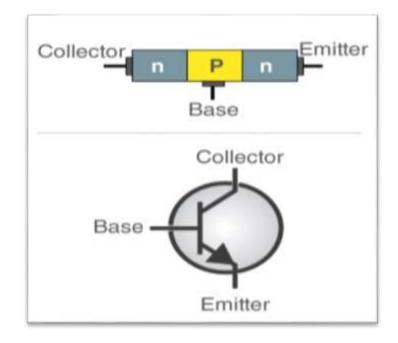
Bipolar Junction Transistor (BJT)

☐ The three terminals of BJT are the base, emitter and collector. A very small current flowing between the base and emitter can control a larger flow of current between the collector and emitter terminal.



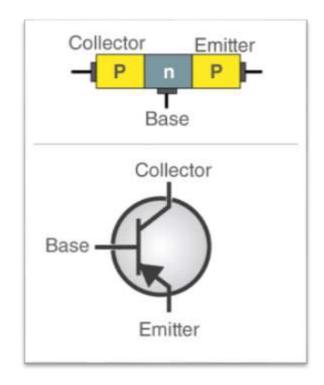
NPN

- □ N-P-N Transistor: In this transistor, we will find one ptype material that is present between two n-type materials.
 - 1. N-P-N transistor is basically used to amplify weak signals to strong signals.
 - 2. In an NPN transistor, the electrons move from the emitter to the collector region, resulting in the formation of current in the transistor. This transistor is widely used in the circuit.

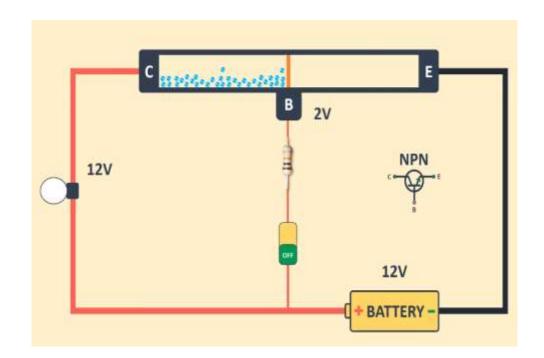


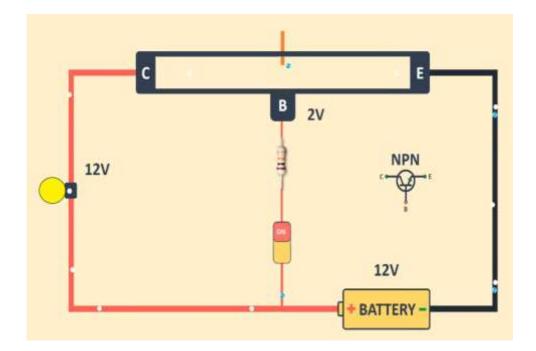
PNP

- □ P-N-P Transistor: It is a type of BJT where one n-type material is introduced or placed between two p-type materials. In such a configuration, the device will control the flow of current.
 - 1. PNP transistor consists of 2 crystal diodes which are connected in series. The right side and left side of the diodes are known as the collector-base diode and emitter-base diode, respectively.

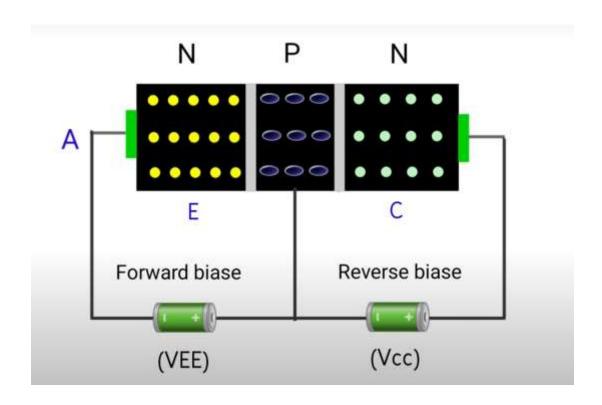


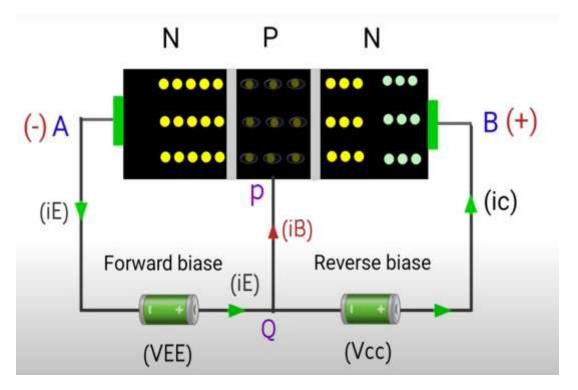
How Do Transistors Work?



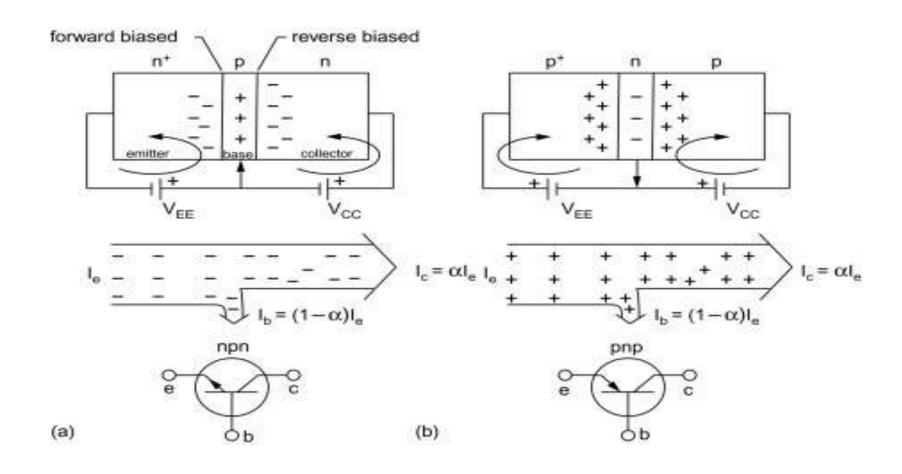


Operation of NPN Transistor



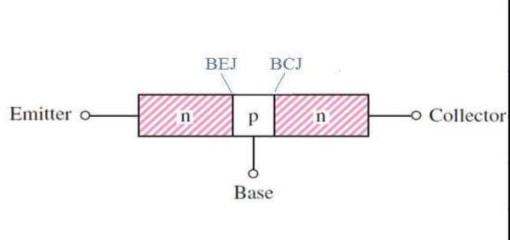


Operation of PNP Transistor



Operation of PNP Transistor

- A single p-n junction has two different types of bias:
- Forward Bias
- Reverse Bias
- Thus, a two pn-jnuction device has four types of bias.

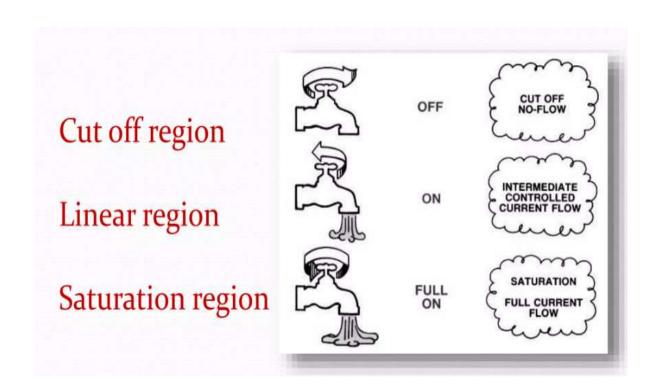


BC junction (BCJ)	BE junction (BEJ)	Mode of operation
Reverse	Reverse	Cut-off
Forward	Reverse	Cut-off
Reverse	Forward	Active
Forward	Forward	Saturation

Limitations of Transistors

- ☐ Transistors have a few limitations, and they are as follows:
 - i. Transistors lack higher electron mobility.
 - ii. Transistors can be easily damaged when electrical and thermal events arise.
 - iii. For example, electrostatic discharge in handling.
 - iv. Transistors are affected by cosmic rays and radiation.

Operation Regions of BJT



Operation Regions of BJT

OFF Mode (Cutoff Region)

- •No base current (lb = 0).
- •No current flows between collector and emitter (Ic = 0).
- •Transistor acts as an open switch.

ON Mode (Saturation Region)

- •Base current is high.
- •Maximum current flows from collector to emitter.
- Transistor acts as a closed switch.

Amplification Mode (Active Region)

- •A small base current controls a large collector-emitter current.
- •Transistor acts as an amplifier.

Common configuration

1. Common Emitter Configuration – has both Current and Voltage Gain.

2. Common Base Configuration – has Voltage Gain but no Current Gain.

3. Common Collector Configuration – has Current Gain but no Voltage Gain.

Common configuration

Emitter and collector currents:

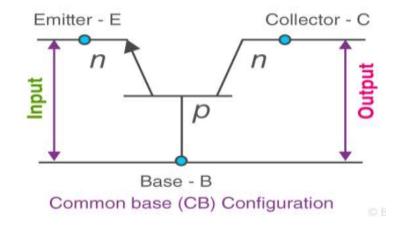
$$I_C \cong I_E$$

Base-emitter voltage:

$$V_{BE} = 0.7 V$$
 (for Silicon)

Common Base (CB)

☐ In common base (CB) configuration, the base terminal of the transistor is common between input and output terminals.



Current Amplification Factor α

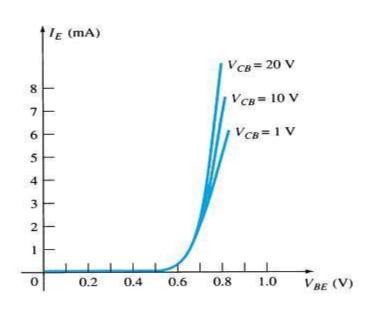
The ratio of change in collector current ΔI_C to the change in emitter current ΔI_E when collector voltage $\mathbf{V_{CB}}$ is kept constant, is called as **Current amplification factor**. It is denoted by a.

$$lpha = rac{\Delta I_C}{\Delta I_E} \ at \ constant \ V_{CB}$$

Common Base (CB)

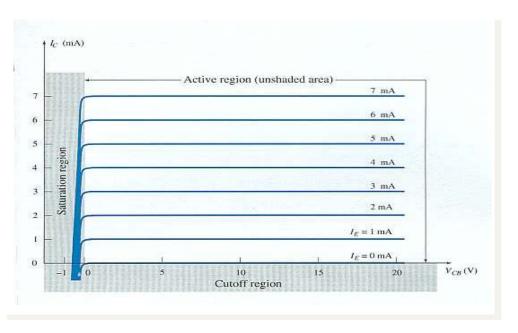
Input Characteristics

This curve shows the relationship between of input current (I_E) to input voltage (V_{BE}) for three output voltage (V_{CB}) levels.



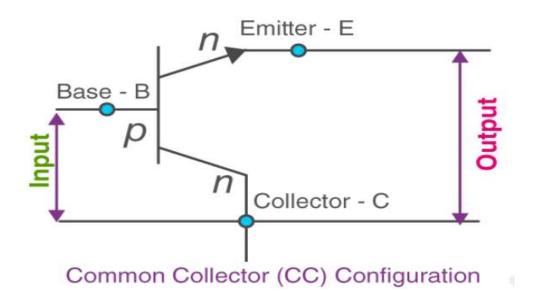
Output Characteristics

This graph demonstrates the output current (I_C) to an output voltage (V_{CB}) for various levels of input current (I_E) .



Common Collector (CC)

☐ In common collector (CC) configuration, the collector terminals are common between the input and output terminals.

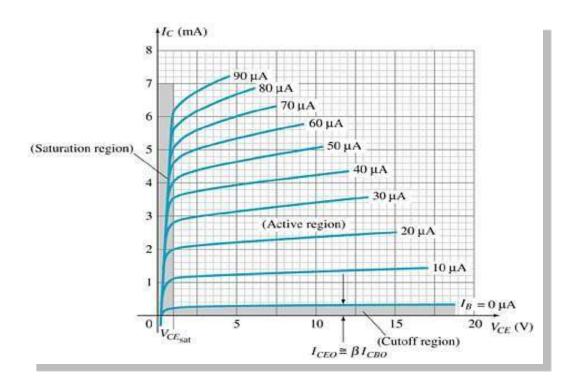


The ratio of change in emitter current ΔI_E to the change in base current ΔI_B is known as **Current Amplification factor** in common collector CC configuration. It is denoted by \mathbf{y} .

$$\gamma = rac{\Delta I_E}{\Delta I_B}$$

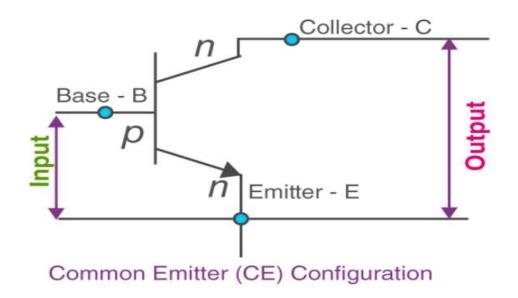
Common Collector (CC)

The characteristics are similar to those of the common-emitter configuration, except the vertical axis is $I_{\rm E}$.



Common Emitter (CE)

☐ In common emitter (CE) configuration, the emitter terminal is common between the input and the output terminals.

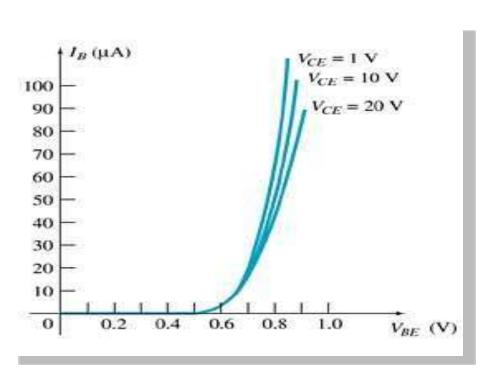


Base Current Amplification factor β

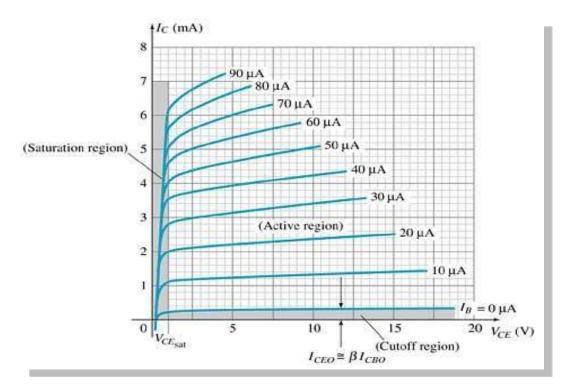
The ratio of change in collector current ΔI_C to the change in base current ΔI_B is known as **Base Current Amplification Factor**. It is denoted by β

$$\beta = \frac{\Delta I_C}{\Delta I_B}$$

Common Emitter (CE)



Base Characteristics



Collector Characteristics

Amplification Factor

Relation between β and α

Let us try to derive the relation between base current amplification factor and emitter current amplification factor.

$$\beta = \frac{\Delta I_C}{\Delta I_B}$$

$$lpha = rac{\Delta I_C}{\Delta I_E}$$

$$I_E = I_B + I_C$$

$$\Delta I_E = \Delta I_B + \Delta I_C$$

$$\Delta I_B \,=\, \Delta I_E \,-\, \Delta I_C$$

We can write

$$\beta = \frac{\Delta I_C}{\Delta I_E - \Delta I_C}$$

Dividing by \$\$

$$\beta = \frac{\frac{\Delta I_C}{\Delta I_E}}{\frac{\Delta I_E}{\Delta I_E} - \frac{\Delta I_C}{\Delta I_E}}$$

$$\Delta I_C$$

$$lpha = rac{\Delta I_C}{\Delta I_E}$$

We have

$$\alpha = \frac{\Delta I_C}{\Delta I_E}$$

Therefore,

$$\beta = \frac{\alpha}{1-\alpha}$$

Amplification Factor

Relation between y and a

Let us try to draw some relation between γ and α

$$egin{aligned} \gamma &= rac{\Delta I_E}{\Delta I_B} \ & lpha &= rac{\Delta I_C}{\Delta I_E} \ & I_E &= I_B \, + \, I_C \ & \Delta I_E &= \Delta I_B \, + \, \Delta I_C \ & \Delta I_B &= \Delta I_E \, - \, \Delta I_C \end{aligned}$$

Substituting the value of IR, we get

$$\gamma = rac{\Delta I_E}{\Delta I_E - \Delta I_C}$$

Dividing by ΔI_E

$$\gamma = rac{rac{\Delta I_E}{\Delta I_E}}{rac{\Delta I_E}{\Delta I_E} - rac{\Delta I_C}{\Delta I_E}} \ rac{1}{1-lpha} \ \gamma = rac{1}{1-lpha}$$

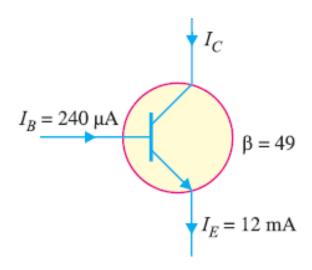
Transistor Simple Mathematical Problem

- \Box In a common base connection, IE = 1mA, IC = 0.95mA. Calculate the value of IB.
- ☐ In a common base connection, current amplification factor is 0.9. If the emitter current is 1mA, determine the value of base current.
- \Box In a common base connection, IC = 0.95 mA and IB = 0.05 mA. Find the value of α .
- \Box In a common base connection, the emitter current is 1mA. If the emitter circuit is open, the collector current is 50 μA. Find the total collector current. Given that $\alpha = 0.92$.

Here,
$$I_E = 1 \text{ mA}$$
, $\alpha = 0.92$, $I_{CBO} = 50 \text{ µA}$
Total collector current, $I_C = \alpha I_E + I_{CBO} = 0.92 \times 1 + 50 \times 10^{-3}$
 $= 0.92 + 0.05 = 0.97 \text{ mA}$

Transistor Simple Mathematical Problem

 \Box Find the α rating of the transistor shown in Fig. Hence determine the value of IC using both α and β rating of the transistor.



Solve

$$\alpha = \frac{\beta}{1+\beta} = \frac{49}{1+49} = 0.98$$

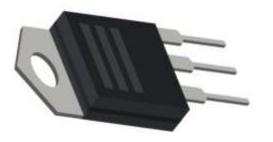
The value of I_C can be found by using either α or β rating as under:

$$I_C = \alpha I_E = 0.98 (12 \text{ mA}) = 11.76 \text{ mA}$$

Also $I_C = \beta I_B = 49 (240 \text{ }\mu\text{A}) = 11.76 \text{ mA}$

What Is a MOSFET?

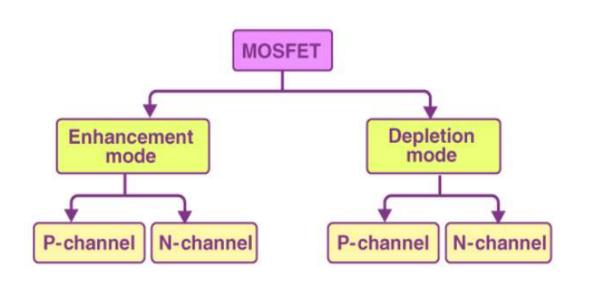
☐ Metal Oxide Silicon Field Effect Transistors commonly known as MOSFETs are electronic devices used to switch or amplify voltages in circuits. It is a voltage controlled device and is constructed by three terminals. The terminals of MOSFET are named as follows:

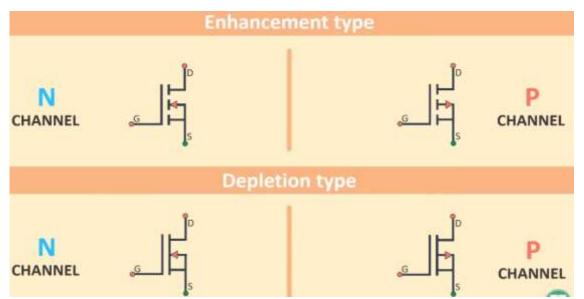


- Source
- •Gate
- Drain

MOSFET Types

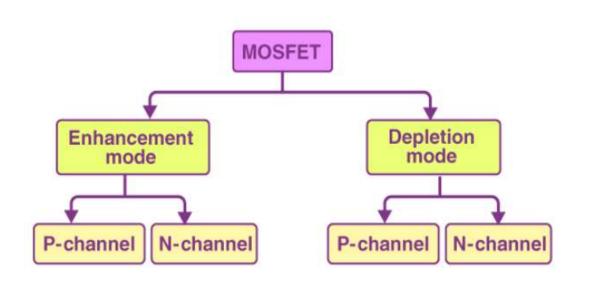
☐ The classification of MOSFET based on the construction and the material used is given below in the flowchart.

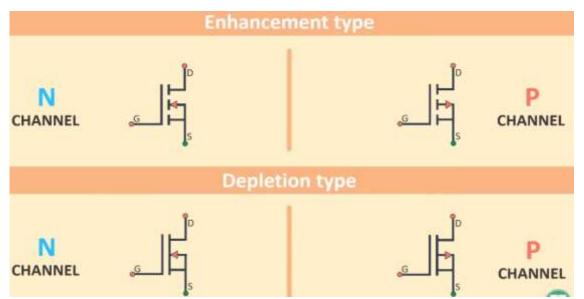




MOSFET Types

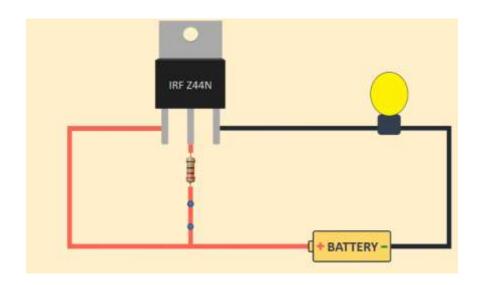
☐ The classification of MOSFET based on the construction and the material used is given below in the flowchart.

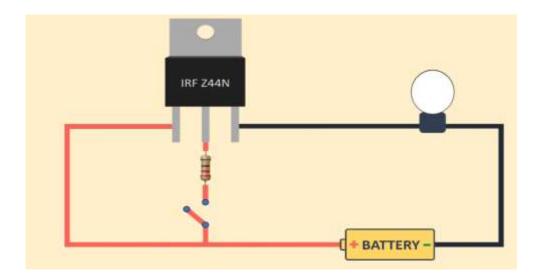




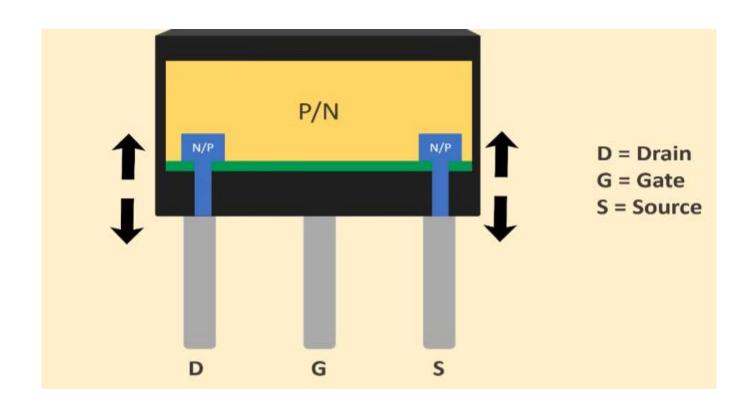
Working Principle of MOSFET

☐ When voltage is applied to the gate, an electrical field is generated that changes the width of the channel region, where the electrons flow. The wider the channel region, the better conductivity of a device will be.

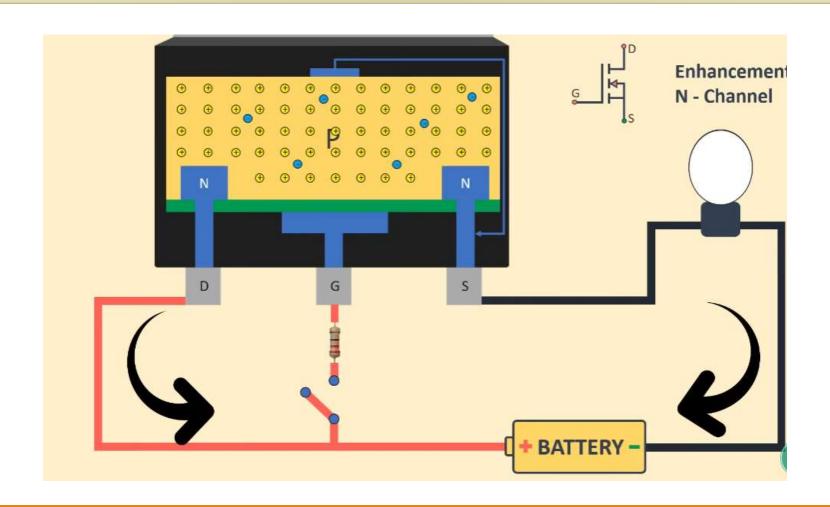




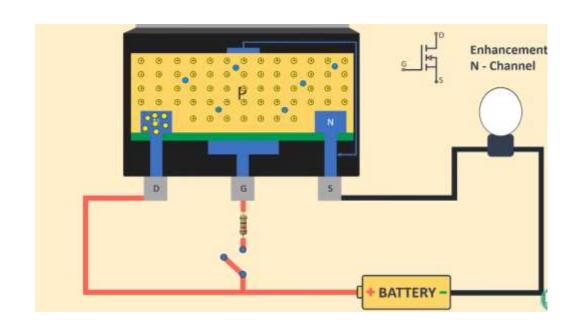
Working Principle of MOSFET

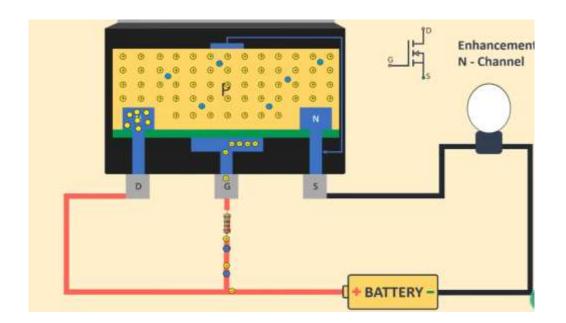


Enhancement N - Channel MOSFET

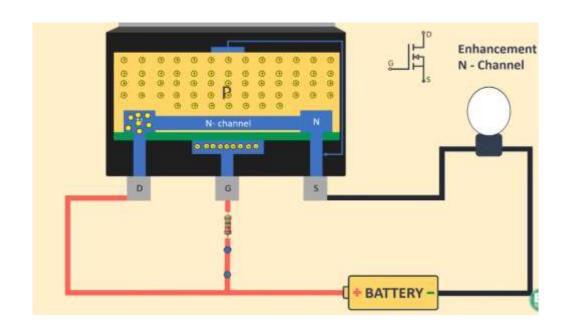


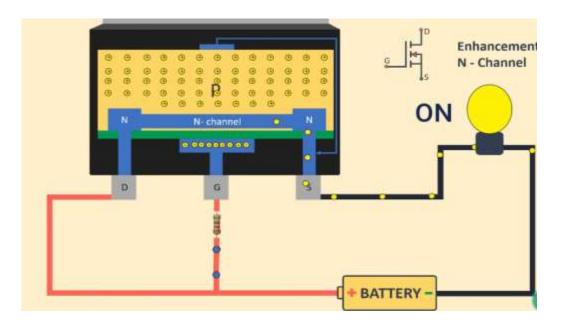
Enhancement N - Channel MOSFET



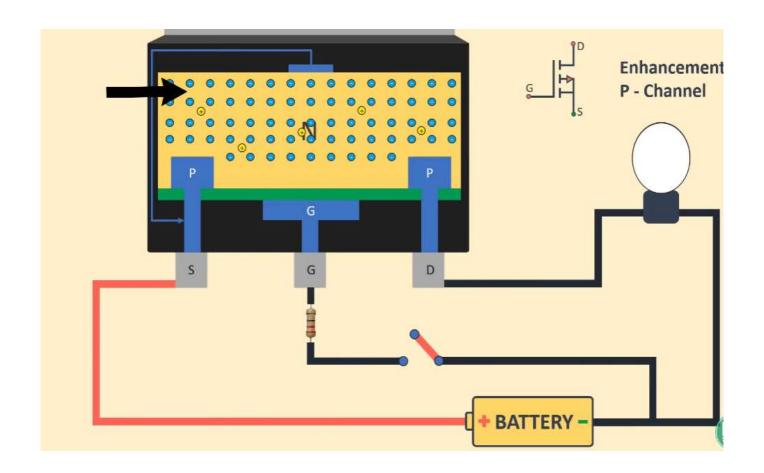


Enhancement N - Channel MOSFET

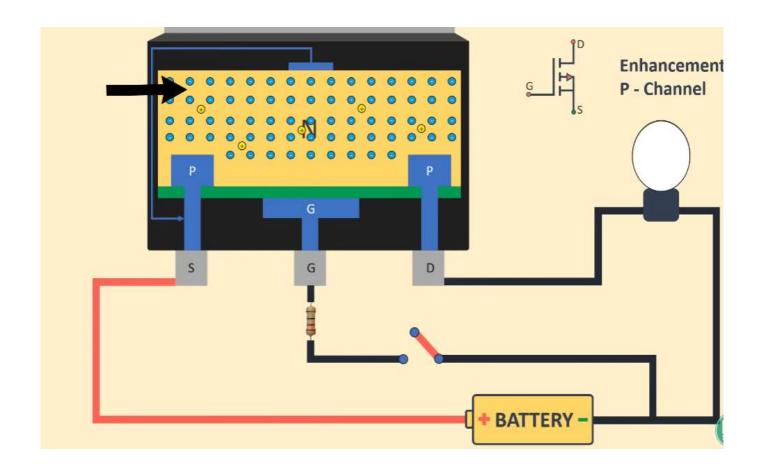




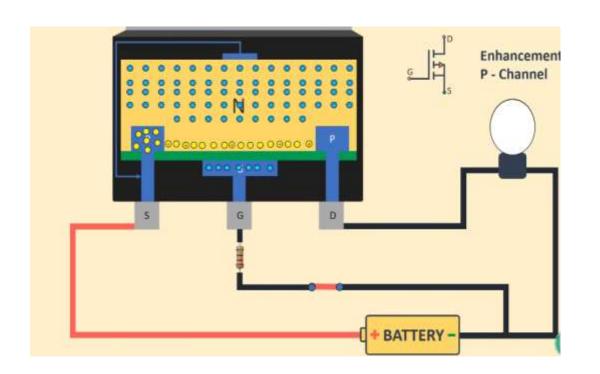
Enhancement P - Channel MOSFET

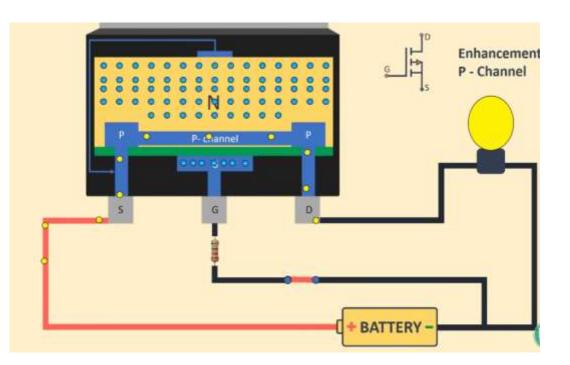


Enhancement P - Channel MOSFET

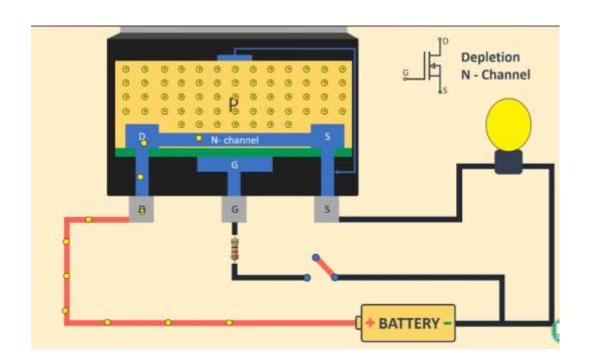


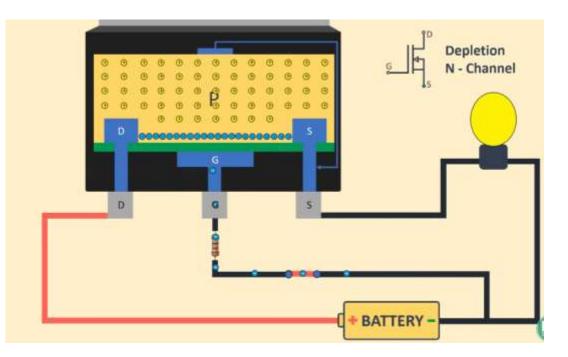
Enhancement P - Channel MOSFET



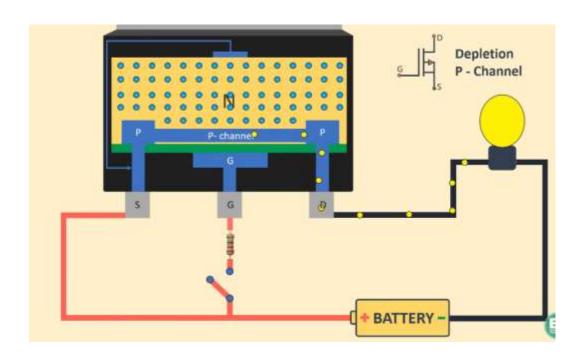


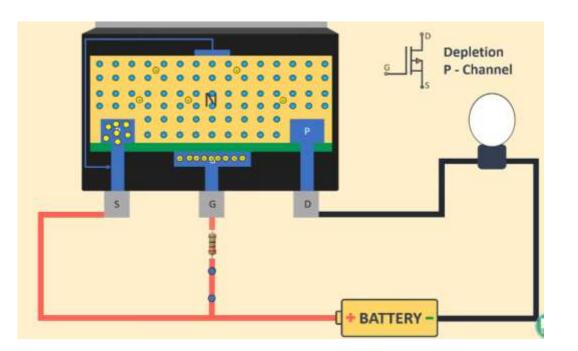
Depletion N - Channel MOSFET



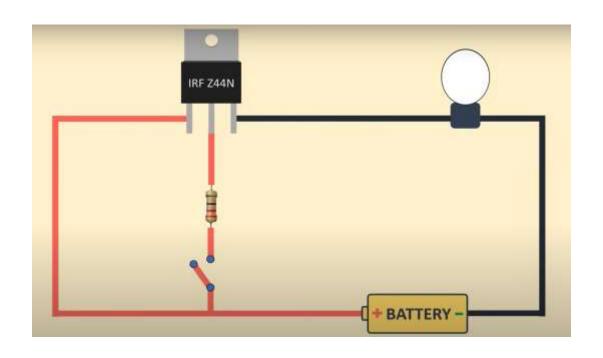


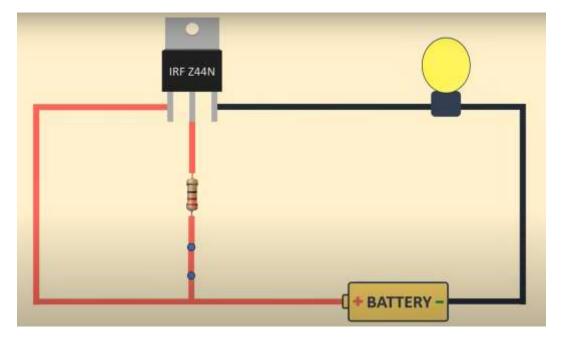
Depletion N - Channel MOSFET



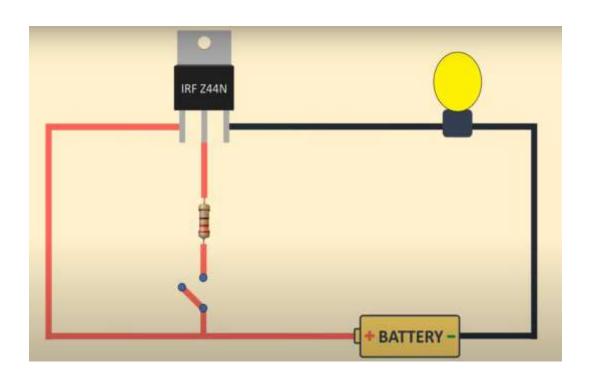


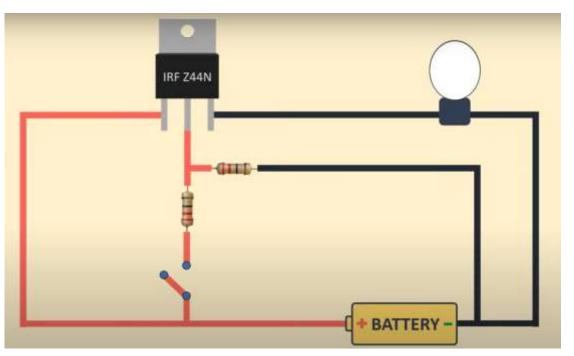
MOSFET Setup





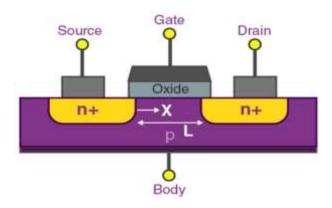
MOSFET Setup





MOSFET Construction

- The p-type semiconductor forms the base of the MOSFET.
- > The two types of the base are highly doped with an n-type impurity which is marked as n+ in the diagram.
- From the heavily doped regions of the base, the terminals source and drain originate.
- > The layer of the substrate is coated with a layer of silicon dioxide for insulation.
- A thin insulated metallic plate is kept on top of the silicon dioxide and it acts as a capacitor.
- > The gate terminal is brought out from the thin metallic plate.
- A DC circuit is then formed by connecting a voltage source between these two n-type regions.



Operating Regions of MOSFET

A MOSFET is seen to exhibit three operating regions. Here, we will discuss those regions.

□Cut-Off Region

The cut-off region is a region in which there will be no conduction and as a result, the MOSFET will be OFF. In this condition, MOSFET behaves like an open switch.

□Ohmic Region

The ohmic region is a region where the current (I_{DS}) increases with an increase in the value of V_{DS} . When MOSFETs are made to operate in this region, they are used as amplifiers.

☐ Saturation Region

In the saturation region, the MOSFETs have their I_{DS} constant in spite of an increase in V_{DS} and occurs once V_{DS} exceeds the value of pinch-off voltage V_{D} . Under this condition, the device will act like a closed switch through which a saturated value of I_{DS} flows. As a result, this operating region is chosen whenever MOSFETs are required to perform switching operacses 33@DIU, SUMMER 2025

Symbols details

I_D (Drain Current) - The current flowing from drain to source in a MOSFET.

I_D(on) (Drain Current when ON) - The drain current when the MOSFET is fully turned ON.

V_GS (**Gate-Source Voltage**) - The voltage applied between the gate and source terminals.

V_GS(off) (Gate-Source Cutoff Voltage) - The gate-source voltage at which the MOSFET turns OFF (for JFETs and depletion-mode MOSFETs).

V_GS(th) (Threshold Voltage) - The minimum gate-source voltage required to turn ON an enhancement-mode MOSFET.

Example

Example 19.32. Determine the drain-to-source voltage (V_{DS}) in the circuit shown in Fig. 19.51 above if $V_{DD} = +18V$ and $R_D = 620\Omega$. The MOSFET data sheet gives $V_{GS (off)} = -8V$ and $I_{DSS} = 12$ mA.

Solution. Since
$$I_D = I_{DSS} = 12 \text{ mA}$$
, the I'_{DS} is given by;

$$I'_{DS} = I'_{DD} - I_{DSS} R_D$$

$$= 18V - (12 \text{ mA}) (0.62 \text{ k}\Omega) = 10.6V$$

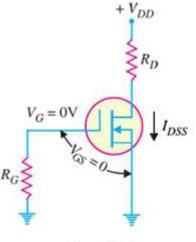


Fig. 19.51

Example

Example 19.33. The D-MOSFET used in the amplifier of Fig. 19.54 has an $I_{DSS} = 12$ mA and $g_m = 3.2$ mS. Determine (i) d.c. drain-to-source voltage V_{DS} and (ii) a.c. output voltage. Given $v_{in} = 500$ mV.

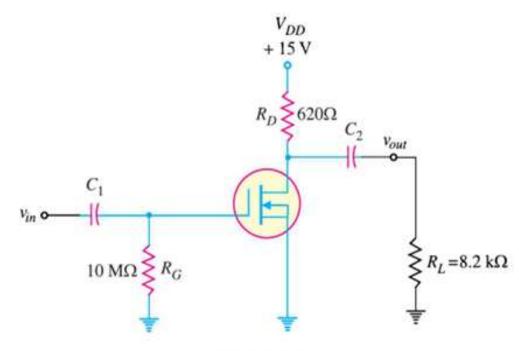


Fig. 19.54

Example

Example 19.33. The D-MOSFET used in the amplifier of Fig. 19.54 has an $I_{DSS} = 12$ mA and $g_m = 3.2$ mS. Determine (i) d.c. drain-to-source voltage V_{DS} and (ii) a.c. output voltage. Given $v_{in} = 500$ mV.

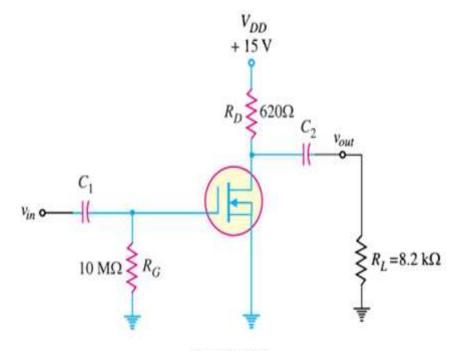


Fig. 19.54

Solution.

(i) Since the amplifier is zero biased, $I_D = I_{DSS} = 12 \text{ mA}$.

$$V_{DS} = V_{DD} - I_{DSS} R_D$$

= 15V - (12 mA) (0.62 kΩ) = 7.56V

(ii) Total a.c. drain resistance R_{AC} of the circuit is

$$R_{AC} = R_D || R_L = 620\Omega || 8.2 \text{ k}\Omega = 576\Omega$$

$$v_{out} = A_v \times v_{in} = (g_m R_{AC}) (v_{in})$$

$$= (3.2 \times 10^{-3} \text{ S} \times 576 \Omega) (500 \text{ mV}) = 922 \text{ mV}$$

Example

Example 19.37. Determine the values of I_D and V_{DS} for the circuit shown in Fig. 19.62. The data sheet for this particular MOSFET gives $I_{D(on)} = 10$ mA when $V_{GS} = V_{DS}$

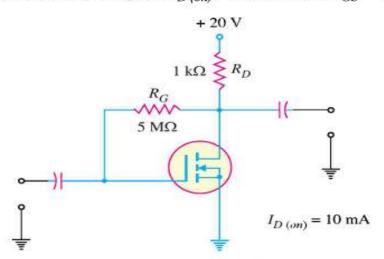


Fig. 19.62

Solution. Since in the drain-feedback circuit $V_{GS} = V_{DS}$,

$$I_D = I_{D(on)} = 10 \text{ mA}$$

The value of V_{DS} (and thus V_{GS}) is given by;

$$V_{DS} = V_{DD} - I_D R_D$$

= 20V - (10 mA) (1 k Ω) = 20V - 10V = **10V**

MOSFET vs BJT

MOSFET	ВЈТ
There are two types of MOSFET and they are named: N-type or P-type	BJT is of two types and they are named as: PNP and NPN
MOSFET is a voltage-controlled device	BJT is a current-controlled device
The input resistance of MOSFET is high.	The input resistance of BJT is low.
Used in high current applications	Used in low current applications

MOSFET Applications

- > Radiofrequency applications use MOSFET amplifiers extensively.
- > MOSFET behaves as a passive circuit element.
- > Power MOSFETs can be used to regulate DC motors.
- > MOSFETs are used in the design of the chopper circuit.

Advantages & Disadvantages

□ Advantages of MOSFET

- MOSFETs operate at greater efficiency at lower voltages.
- Absence of gate current results in high input impedance producing high switching speed.

□ Disadvantages of MOSFET

- MOSFETs are vulnerable to damage by electrostatic charges due to the thin oxide layer.
- Overload voltages make MOSFETs unstable.

Thank you for hearing with patience